150MHz, 250V/µs, $A_V \geq 4$ Operational Amplifier

FEATURES

- **Gain-Bandwidth: 150MHz**
- **Gain of 4 Stable**
- **Slew Rate: 250V/µs**
- Input Noise Voltage: 6nV/√Hz
- C-Load™ Op Amp Drives Capacitive Loads
- Maximum Input Offset Voltage: 600µV
- Maximum Input Bias Current: 300nA
- Maximum Input Offset Current: 300nA
- Minimum Output Swing Into 500Ω: ±12V
- Minimum DC Gain: 50V/mV, R_L = 500Ω
- Settling Time to 0.1%: 65ns, 10V Step
- Settling Time to 0.01%: 85ns, 10V Step
- Differential Gain: 0.08%, A_V = 4, R_L = 150Ω
- Differential Phase: 0.2°, A_V = 4, R_L = 150Ω

APPLICATIONS

- Wideband Amplifiers
- Buffers
- Active Filters
- Video and RF Amplification
- Cable Drivers
- 8-, 10-, 12-Bit Data Acquisition Systems

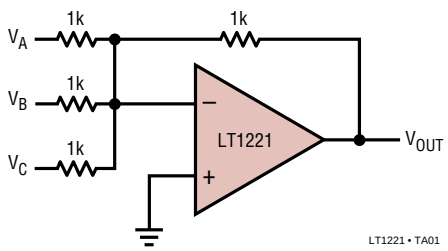
DESCRIPTION

The LT®1221 is a very high speed operational amplifier with superior DC performance. The LT1221 is stable in a noise gain of 4 or greater. It features reduced input offset voltage, lower input bias currents and higher DC gain than devices with comparable bandwidth and slew rate. The circuit is a single gain stage that includes proprietary DC gain enhancement circuitry to obtain precision with high speed. The high gain and fast settling time make the circuit an ideal choice for data acquisition systems. The circuit is also capable of driving capacitive loads which makes it useful in buffer or cable driver applications.

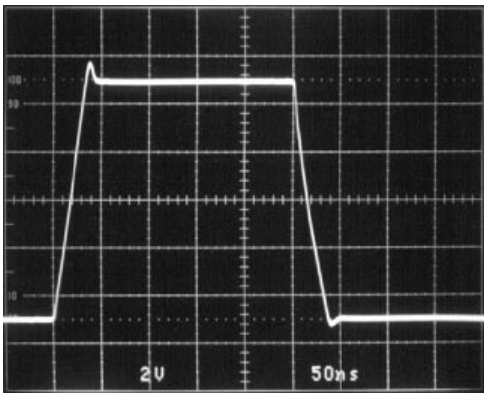
The LT1221 is a member of a family of fast, high performance amplifiers that employ Linear Technology Corporation's advanced complementary bipolar processing. For unity-gain stable applications the LT1220 can be used, and for gains of 10 or greater the LT1222 can be used.

TYPICAL APPLICATION

Summing Amplifier



Summing Amplifier Large-Signal Response



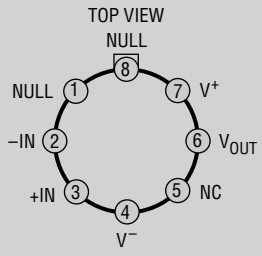
V_S = ±15V f = 2MHz
V_{IN} = $10V_{P-P}$

LT1221 • TA02

ABSOLUTE MAXIMUM RATINGS (Note 1)

Total Supply Voltage (V^+ to V^-) 36V
Differential Input Voltage ..... ±6V
Input Voltage ..... $\pm V_S$
Output Short-Circuit Duration (Note 2) ..... Indefinite
Specified Temperature Range
LT1221C (Note 3) ..... 0°C to 70°C
LT1221M **(OBSOLETE)** ..... –55°C to 125°C
Operating Temperature Range
LT1221C ..... –40°C TO 85°C
LT1221M **(OBSOLETE)** ..... –55°C to 125°C
Maximum Junction Temperature (See Below)
Plastic Package ..... 150°C
Ceramic Package **(OBSOLETE)** ..... 175°C
Storage Temperature Range ..... –65°C to 150°C
Lead Temperature (Soldering, 10 sec) ..... 300°C

PACKAGE/ORDER INFORMATION

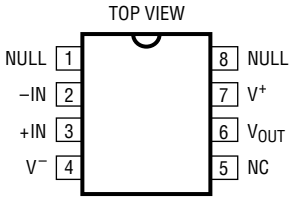


H PACKAGE
8-LEAD TO-5 METAL CAN
T_{JMAX} = 175°C, θ_{JA} = 150°C/W

ORDER PART NUMBER

SPECIAL ORDER CONSULT FACTORY

OBSOLETE PACKAGE
Consider the N8 or S8 Package for Alternate Source



N8 PACKAGE
8-LEAD PLASTIC DIP
T_{JMAX} = 150°C, θ_{JA} = 130°C/W (N)

S8 PACKAGE
8-LEAD PLASTIC SOIC
T_{JMAX} = 150°C, θ_{JA} = 190°C/W (S)

J8 PACKAGE
8-LEAD CERAMIC DIP
T_{JMAX} = 175°C, θ_{JA} = 100°C/W (J)

ORDER PART NUMBER

LT1221CN8
LT1221CS8

S8 PART MARKING

1221

ORDER PART NUMBER

LT1221MJ8

OBSOLETE PACKAGE
Consider the N8 Package for Alternate Source

Consult LTC Marketing for parts specified with wider operating temperature ranges.

ELECTRICAL CHARACTERISTICS

T_A = 25°C, V_S = ±15V, T_A = 25°C, V_{CM} = 0V, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V_{OS}	Input Offset Voltage	(Note 4)		200	600	µV
I_{OS}	Input Offset Current			100	300	nA
I_B	Input Bias Current			100	300	nA
e_n	Input Noise Voltage	f = 10kHz		6		nV/√Hz
i_n	Input Noise Current	f = 10kHz		2		pA/√Hz
R_{IN}	Input Resistance	V_{CM} = ±12V Differential	20	45 80		MΩ kΩ
C_{IN}	Input Capacitance			2		pF
	Input Voltage Range (Positive) Input Voltage Range (Negative)		12	14 –13	 –12	V V
CMRR	Common Mode Rejection Ratio	V_{CM} = ±12V	92	114		dB
PSRR	Power Supply Rejection Ratio	V_S = ±5V to ±15V	90	110		dB
A_{VOL}	Large-Signal Voltage Gain	V_{OUT} = ±10V, R_L = 500Ω	50	100		V/mV
V_{OUT}	Output Swing	R_L = 500Ω	12	13		±V
I_{OUT}	Output Current	V_{OUT} = ±12V	24	26		mA
SR	Slew Rate	(Note 5)	200	250		V/µs
	Full Power Bandwidth	10V Peak (Note 6)		4		MHz
GBW	Gain-Bandwidth	f = 1MHz		150		MHz

ELECTRICAL CHARACTERISTICS

$V_S = \pm 15V$, $T_A = 25°C$, $V_{CM} = 0V$, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
t_r, t_f	Rise Time, Fall Time	$A_V = 4$, 10% to 90%, 0.1V		3.2		ns
	Overshoot	$A_V = 4$, 0.1V		10		%
	Propagation Delay	$A_V = 4$, 50% V_{IN} to 50% V_{OUT}, 0.1V		5.4		ns
t_s	Settling Time	10V Step, 0.1% 10V Step, 0.01%		65 85		ns ns
	Differential Gain	f = 3.58MHz, $R_L = 150\Omega$ (Note 7) f = 3.58MHz, R_L = 1k (Note 7)		0.08 0.02		% %
	Differential Phase	f = 3.58MHz, $R_L = 150\Omega$ (Note 7) f = 3.58MHz, R_L = 1k (Note 7)		0.20 0.05		DEG DEG
R_O	Output Resistance	$A_V = 4$, f = 1MHz		0.3		Ω
I_S	Supply Current			8	10.5	mA

The ● denotes the specifications which apply over the temperature range $0°C \le T_A \le 70°C$, otherwise specifications are at $T_A = 25°C$. $V_S = \pm 15V$, $V_{CM} = 0V$, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OS}	Input Offset Voltage	(Note 4)	●		0.2	1.5	mV
	Input V_{OS} Drift		●		15		µV/°C
I_{OS}	Input Offset Current		●		100	400	nA
I_B	Input Bias Current		●		100	400	nA
CMRR	Common Mode Rejection Ratio	$V_{CM} = \pm 12V$	●	92	114		dB
PSRR	Power Supply Rejection Ratio	$V_S = \pm 5V$ to $\pm 15V$	●	90	110		dB
A_{VOL}	Large-Signal Voltage Gain	$V_{OUT} = \pm 10V$, $R_L = 500\Omega$	●	40	100		V/mV
V_{OUT}	Output Swing	$R_L = 500\Omega$	●	12	13		±V
I_{OUT}	Output Current	$V_{OUT} = \pm 12V$	●	24	26		mA
SR	Slew Rate	(Note 5)	●	180	250		V/µs
I_S	Supply Current		●		8	11	mA

The ● denotes the specifications which apply over the temperature range $-55°C \le T_A \le 125°C$, otherwise specifications are at $T_A = 25°C$. $V_S = \pm 15V$, $V_{CM} = 0V$, unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
V_{OS}	Input Offset Voltage	(Note 4)	●		0.2	2	mV
	Input V_{OS} Drift		●		15		µV/°C
I_{OS}	Input Offset Current		●		100	800	nA
I_B	Input Bias Current		●		100	1000	nA
CMRR	Common Mode Rejection Ratio	$V_{CM} = \pm 12V$	●	92	114		dB
PSRR	Power Supply Rejection Ratio	$V_S = \pm 5V$ to $\pm 15V$	●	90	110		dB
A_{VOL}	Large-Signal Voltage Gain	$V_{OUT} = \pm 10V$, $R_L = 500\Omega$	●	12.5	100		V/mV
V_{OUT}	Output Swing	$R_L = 500\Omega$ R_L = 1k	● ●	10 12	13 13		±V ±V
I_{OUT}	Output Current	$V_{OUT} = \pm 10V$ $V_{OUT} = \pm 12V$	● ●	20 12	26 13		mA mA
SR	Slew Rate	(Note 5)	●	130	250		V/µs
I_S	Supply Current		●		8	11	mA

Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: A heat sink may be required when the output is shorted indefinitely.

Note 3: Commercial parts are designed to operate over –40°C to 85°C, but are not tested nor guaranteed beyond 0°C to 70°C. Industrial grade parts specified and tested over –40°C to 85°C are available on special request. Consult factory.

Note 4: Input offset voltage is pulse tested and is exclusive of warm-up drift.

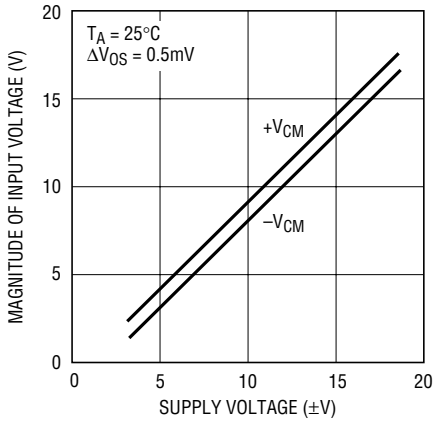
Note 5: Slew rate is measured between ±10V on an output swing of ±12V.

Note 6: FPBW = $SR/2\pi V_P$.

Note 7: Differential Gain and Phase are tested in $A_V = 4$ with five amps in series. Attenuators of 1/4 are used as loads (36.5Ω, 110Ω and 249Ω, 750Ω).

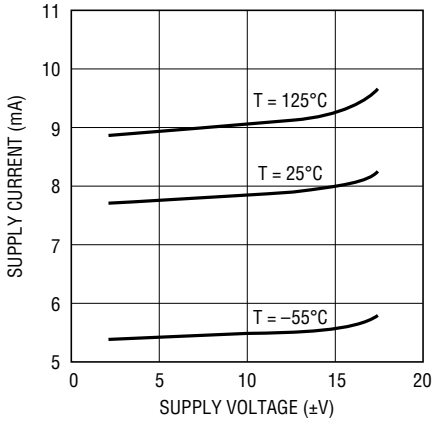
TYPICAL PERFORMANCE CHARACTERISTICS

Input Common Mode Range vs Supply Voltage



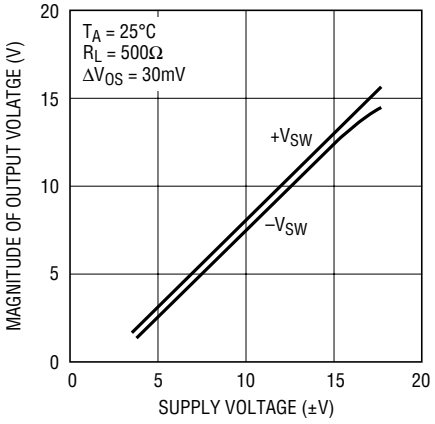
LT1221 • TPC01

Supply Current vs Supply Voltage and Temperature



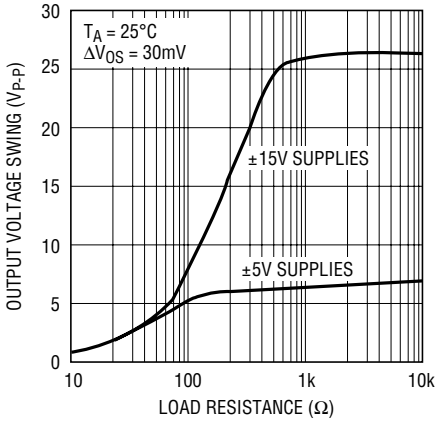
LT1221 • TPC02

Output Voltage Swing vs Supply Voltage



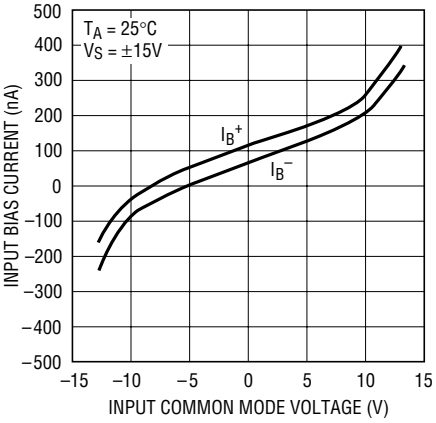
LT1221 • TPC03

Output Voltage Swing vs Resistive Load



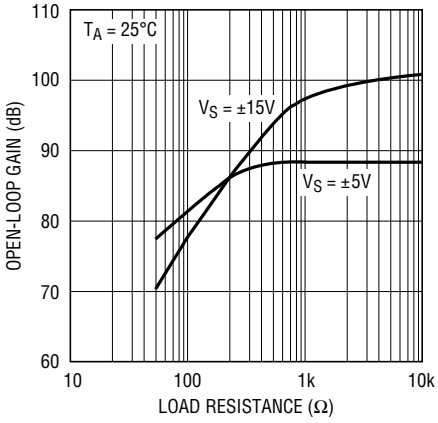
LT1221 • TPC04

Input Bias Current vs Input Common Mode Voltage



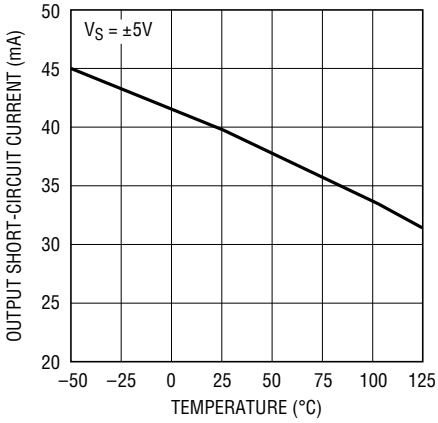
LT1221 • TPC05

Open-Loop Gain vs Resistive Load



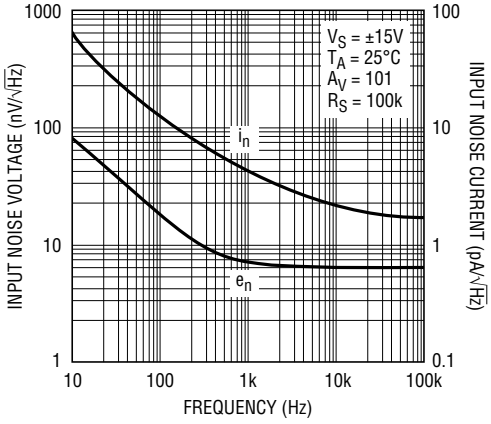
LT1221 • TPC06

Output Short-Circuit Current vs Temperature



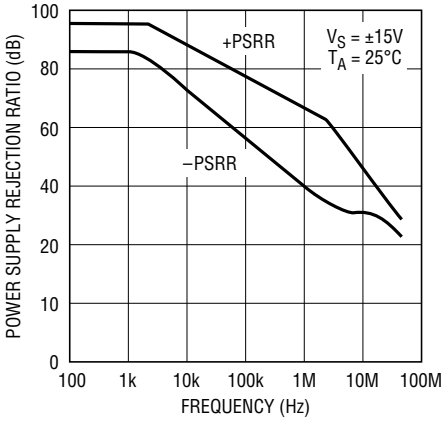
LT1221 • TPC07

Input Noise Spectral Density



LT1221 • TPC08

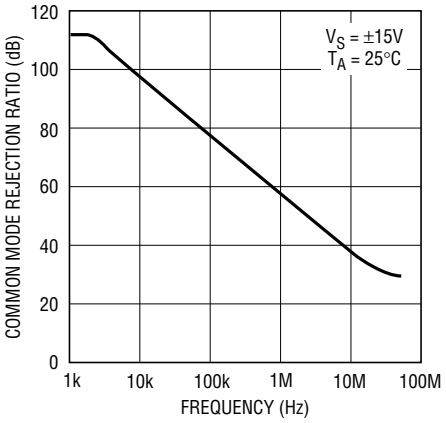
Power Supply Rejection Ratio vs Frequency



LT1221 • TPC09

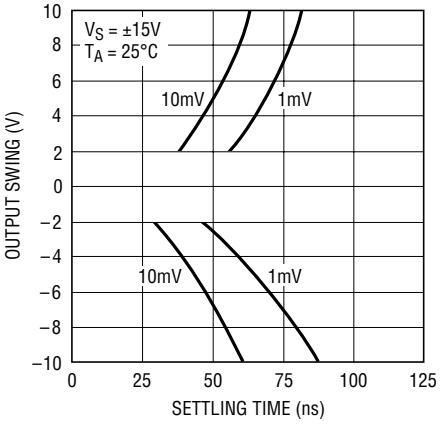
TYPICAL PERFORMANCE CHARACTERISTICS

Common Mode Rejection Ratio vs Frequency



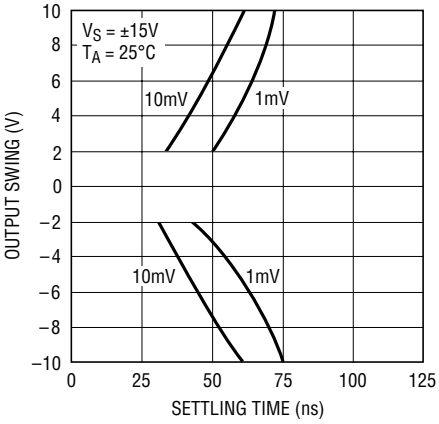
LT1221 • TPC10

Output Swing and Error vs Settling Time (Noninverting)



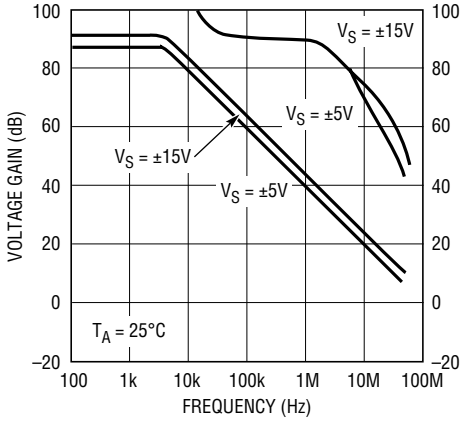
LT1220 • TPC11

Output Swing and Error vs Settling Time (Inverting)



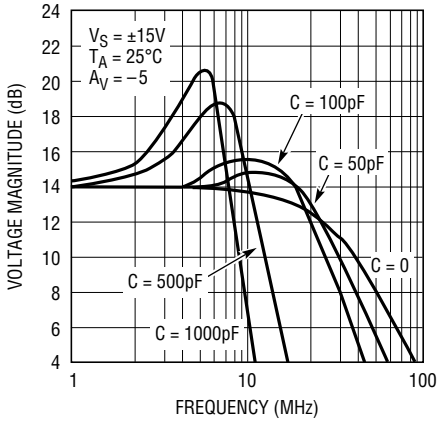
LT1221 • TPC12

Voltage Gain and Phase vs Frequency



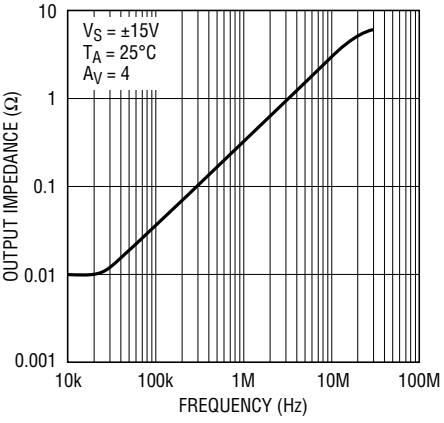
LT1221 • TPC13

Frequency Response vs Capacitive Load



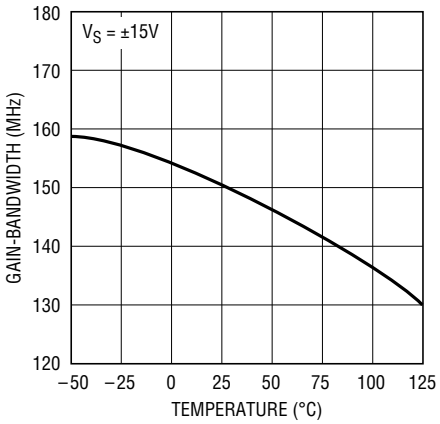
LT1221 • TPC14

Closed-Loop Output Impedance vs Frequency



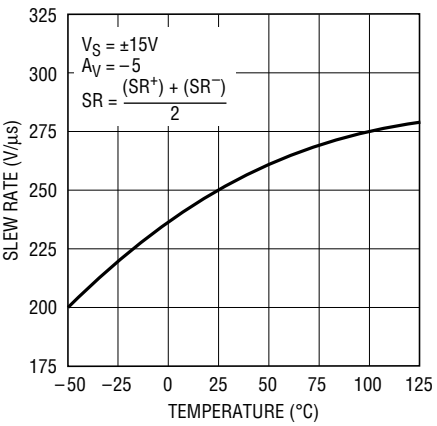
LT1221 • TPC15

Gain-Bandwidth vs Temperature



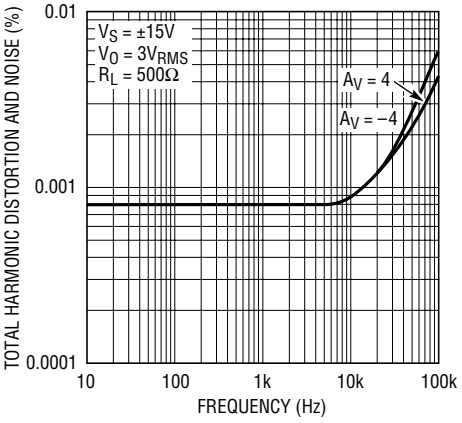
LT1221 • TPC16

Slew Rate vs Temperature



LT1221 • TPC19

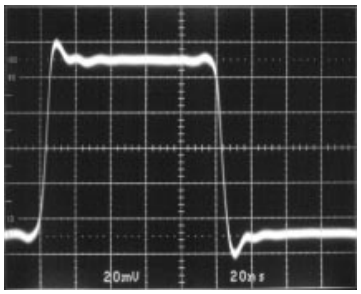
Total Harmonic Distortion vs Frequency



LT1220 • TPC18

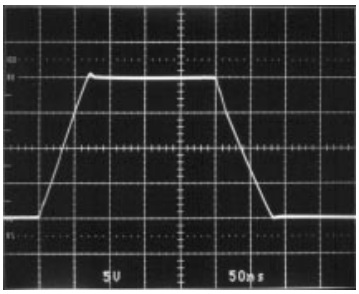
TYPICAL PERFORMANCE CHARACTERISTICS

Small Signal, $A_V = 4$



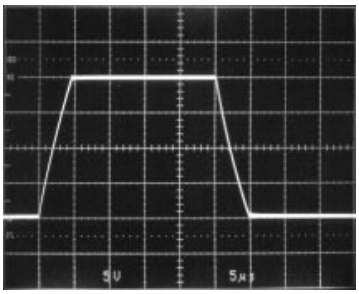
$V_S = \pm 15V$ f = 5MHz
$V_{IN} = 25mV$
LT1221 • TPC19

Large Signal, $A_V = 4$



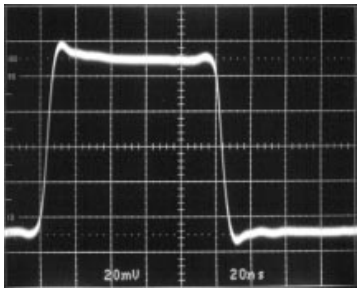
$V_S = \pm 15V$ f = 2MHz
$V_{IN} = 5V_{P-P}$
LT1221 • TPC20

Large Signal, $A_V = 4$, $C_L = 10,000pF$



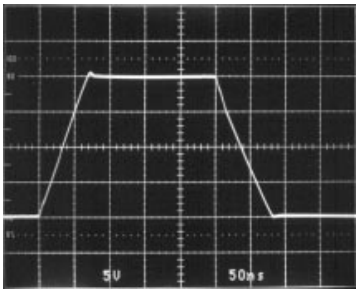
$V_S = \pm 15V$ f = 20kHz
$V_{IN} = 5V_{P-P}$
LT1221 • TPC21

Small Signal, $A_V = -4$



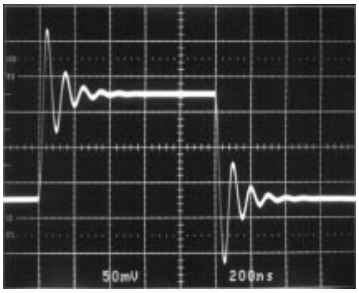
$V_S = \pm 15V$ f = 5MHz
$V_{IN} = 25mV$
LT1221 • TPC22

Large Signal, $A_V = -4$



$V_S = \pm 15V$ f = 2MHz
$V_{IN} = 5V_{P-P}$
LT1221 • TPC23

Small Signal, $A_V = -4$, $C_L = 1,000pF$

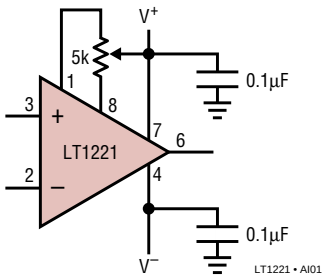


$V_S = \pm 15V$ f = 500kHz
$V_{IN} = 42mV$
LT1221 • TPC24

APPLICATIONS INFORMATION

The LT1221 is stable in noise gains of 4 or greater and may be inserted directly into HA2520/2/5, HA2541/2/4, AD817, AD847, EL2020, EL2044 and LM6361 applications, provided that the nulling circuitry is removed and the amplifier configuration has a high enough noise gain. The suggested nulling circuit for the LT1221 is shown in the following figure.

Offset Nulling



Layout and Passive Components

The LT1221 amplifier is easy to apply and tolerant of less than ideal layouts. For maximum performance (for example, fast settling time) use a ground plane, short lead lengths and RF-quality bypass capacitors (0.01µF to 0.1µF). For high drive current applications use low ESR bypass capacitors (1µF to 10µF tantalum). Sockets should be avoided when maximum frequency performance is required, although low profile sockets can provide reasonable performance up to 50MHz. For more details see Design Note 50. Feedback resistors greater than 5k are not recommended because a pole is formed with the input capacitance which can cause peaking or oscillations.

Input Considerations

Bias current cancellation circuitry is employed on the inputs of the LT1221 so the input bias current and input

APPLICATIONS INFORMATION

offset current have identical specifications. For this reason, matching the impedance on the inputs to reduce bias current errors is not necessary.

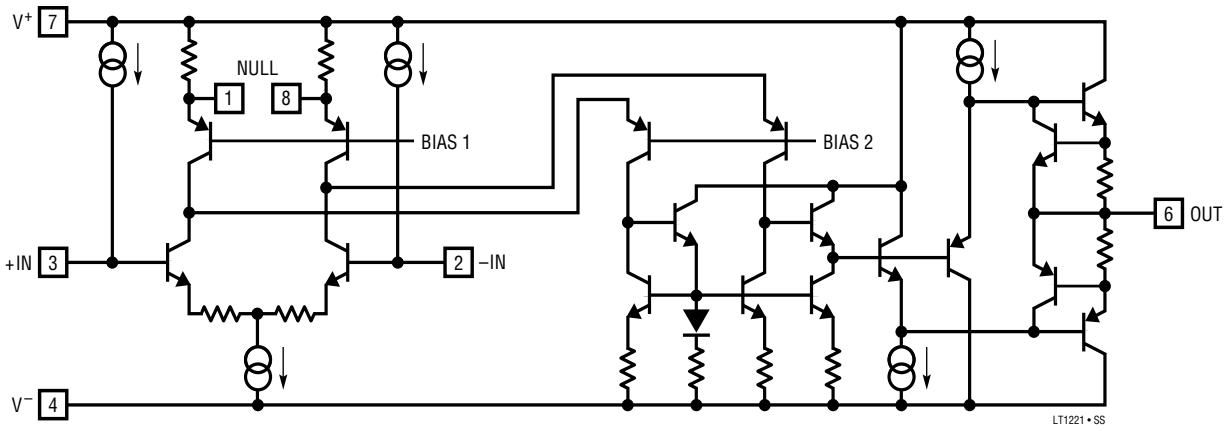
Capacitive Loading

The LT1221 is stable with capacitive loads. This is accomplished by sensing the load induced output pole and adding compensation at the amplifier gain node. As the capacitive load increases, both the bandwidth and phase margin decrease. There will be peaking in the frequency domain as shown in the curve of Frequency Response vs Capacitive Load. The small-signal transient response will have more overshoot as shown in the photo of the small-signal response with 1000pF load. The large-signal response with a 10,000pF load shows the output slew rate being limited to 4V/μs by the short-circuit current. The LT1221 can drive coaxial cable directly, but for best pulse fidelity a resistor of value equal to the characteristic impedance of the cable (i.e., 75Ω) should be placed in series with the output. The other end of the cable should be terminated with the same value resistor to ground.

Compensation

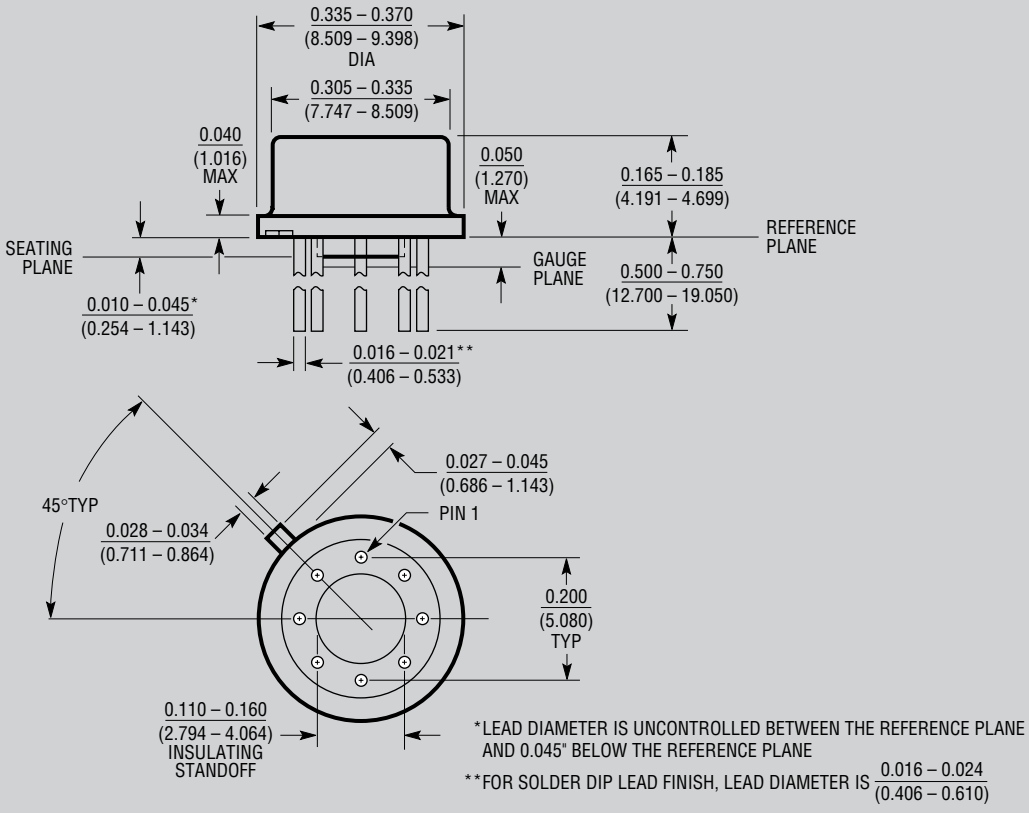
The LT1221 has a typical gain-bandwidth product of 150MHz which allows it to have wide bandwidth in high gain configurations (i.e., in a gain of 10, it will have a bandwidth of about 15MHz). The amplifier is stable in a noise gain of 4 so the ratio of the signal at the inverting input to the output must be 1/4 or less. Straightforward gain configurations of 4 or –3 are stable, but there are several others that allow the amplifier to be stable for lower signal gains (the noise gain, however, remains 4 or more). One example is the summing amplifier on the first page of this data sheet. Each input signal has a gain of –1 to the output, but it is easily seen that this configuration is equivalent to a gain of –3 as far as the amplifier is concerned. Another circuit is shown below with a DC gain of 1, but an AC gain of 5. The break frequency of the R-C combination across the amplifier inputs should be approximately a factor of 10 less than the gain-bandwidth of the amplifier divided by the high frequency gain (in this case 1/10 of 150MHz/5 or 3MHz).

SIMPLIFIED SCHEMATIC



PACKAGE DESCRIPTION

H Package
8-Lead TO-5 Metal Can (.200 Inch PCD)
(Reference LTC DWG # 05-08-1320)



*LEAD DIAMETER IS UNCONTROLLED BETWEEN THE REFERENCE PLANE AND 0.045" BELOW THE REFERENCE PLANE

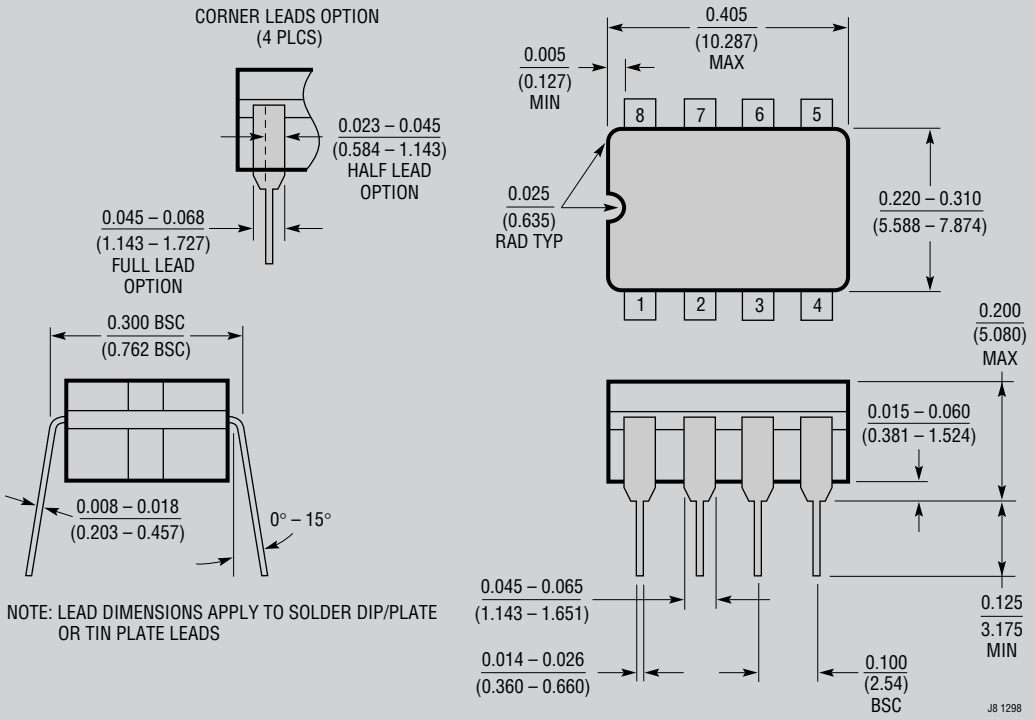
**FOR SOLDER DIP LEAD FINISH, LEAD DIAMETER IS 0.016 – 0.024 (0.406 – 0.610)

H8(TO-5) 0.200 PCD 1197

OBSOLETE PACKAGE

PACKAGE DESCRIPTION

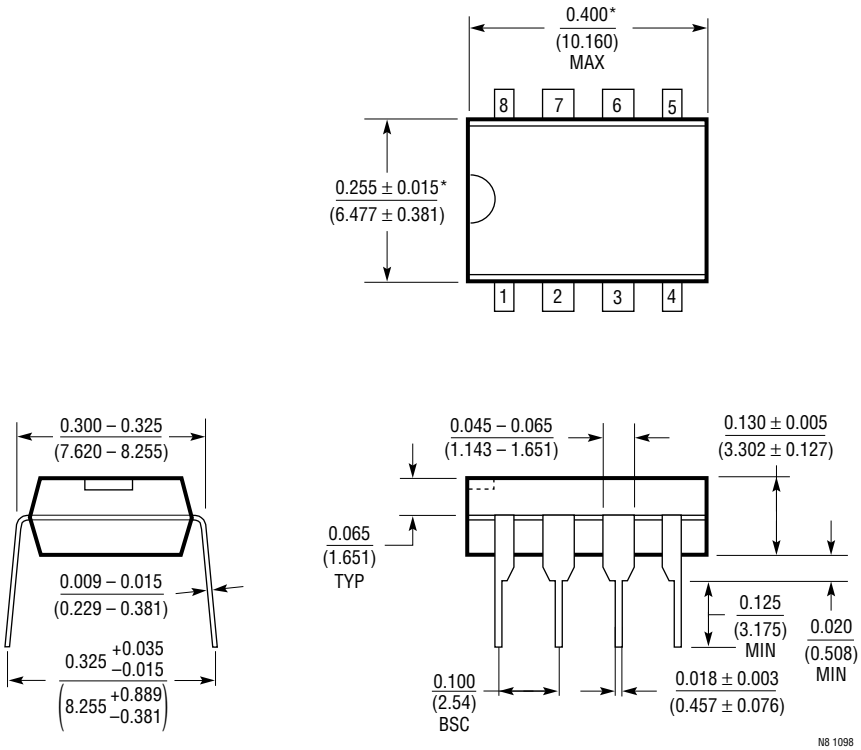
J8 Package
8-Lead CERDIP (Narrow .300 Inch, Hermetic)
(Reference LTC DWG # 05-08-1110)



OBSOLETE PACKAGE

PACKAGE DESCRIPTION

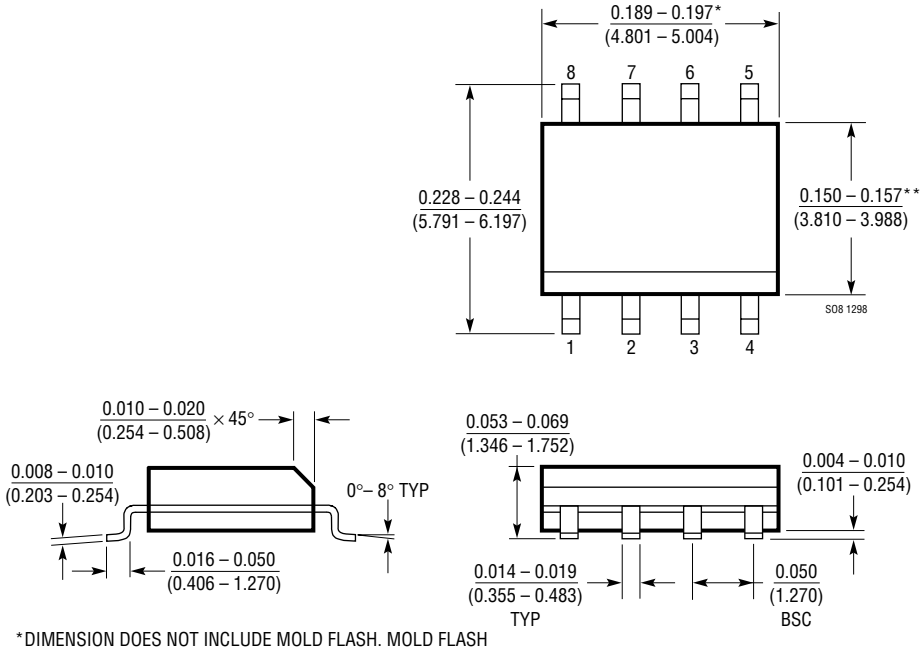
N8 Package
8-Lead PDIP (Narrow .300 Inch)
(Reference LTC DWG # 05-08-1510)



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

PACKAGE DESCRIPTION

S8 Package
8-Lead Plastic Small Outline (Narrow .150 Inch)
(Reference LTC DWG # 05-08-1610)



*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE